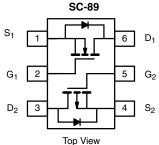


Complementary N- and P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY					
	V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (mA)		
N-Channel	20	5 at V _{GS} = 4.5 V	200		
		7 at V _{GS} = 2.5 V	175		
		9 at V _{GS} = 1.8 V	150		
		10 at V _{GS} = 1.5 V	50		
P-Channel	- 20	8 at V _{GS} = - 4.5 V	- 150		
		12 at V _{GS} = - 2.5 V	- 125		
	- 20	15 at V _{GS} = - 1.8 V	- 100		
		20 at V _{GS} = - 1.5 V	- 30		



Marking Code: M

Ordering Information: Si1035X-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET: 1.5 V Rated
- · Very Small Footprint
- High-Side Switching
- Low On-Resistance: N-Channel, 5 Ω P-Channel, 8 Ω
- Low Threshold: ± 0.9 V (typ.)
- Fast Switching Speed: 45 ns (typ.)
- 1.5 V Operation
- Gate-Source ESD Protected: 2000 V
- Compliant to RoHS Directive 2002/95/EC

BENEFITS

- · Ease in Driving Switches
- · Low Offset (Error) Voltage
- Low-Voltage Operation
- · High-Speed Circuits
- Low Battery Voltage Operation

APPLICATIONS

- · Replace Digital Transistor, Level-Shifter
- · Battery Operated Systems
- · Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)							
			N-Channel		P-Channel		
Parameter		Symbol	5 s	Steady State	5 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	20		- 20		V
Gate-Source Voltage		V_{GS}		±	± 5		ľ
0 D . 0 (T 150.00)3	T _A = 25 °C	- I _D	190	180	- 155	- 145	
Continuous Drain Current $(T_J = 150 ^{\circ}C)^a$	T _A = 85 °C		140	130	- 110	- 105	
Pulsed Drain Current ^b		I _{DM}	650		- 650		mA
Continuous Source Current (Diode Conduction)		I _S	450	380	- 450	- 380	
	T _A = 25 °C	P _D	280	250	280	250	mW
Maximum Power Dissipation ^a	T _A = 85 °C		145	130	145	130	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150			°C	
Gate-Source ESD Rating (HBM, Method 3015)		ESD	2000				V

Notes

- a. Surface mounted on FR4 board.
- b. Pulse width limited by maximum junction temperature.

Pb-free

ROHS COMPLIANT HALOGEN FREE

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Symbol Test Conditions	<u>)</u> μΑ
Gate Threshold Voltage V _{GS} (th) V _{DS} = V _{GS} · I _D = -250 μA P-Ch -0.40 Gate-Body Leakage I _{GSS} V _{DS} = 0 V, V _{GS} = ± 2.8 V N-Ch ± 0.5 ± 1 Zero Gate Voltage Drain Current I _{GSS} V _{DS} = 16 V, V _{GS} = 0 V, V _{GS} = 4.5 V N-Ch ± 1.5 ± 3 V _{DS} = 16 V, V _{GS} = 0 V)) μΑ
Vas = 0 V, Vas = ± 2.8 V)) μΑ
Gate-Body Leakage	<u>)</u> μΑ
Cate-Body Leakage I_GSS I_GSS V_DS = 0 V, V_GS = ± 4.5 V V_DS = 0 V, V_GS = ± 4.5 V V_DS = 16 V, V_GS = 0 V V_DS = 16 V, V_GS = 16 V,	μΑ
$V_{DS} = 0 \text{ V, } V_{QS} = \pm 4.5 \text{ V} \\ P-Ch \\ P-Ch \\ \pm 1.0 \\ \pm 3.3 \\ \pm 3 \\ 10 \text{ Se} \\ 10 \text{ V} \\ P-Ch \\ \pm 1.0 \\ \pm 1.0 \\ \pm 3.3 \\ \pm 3 \\ 10 \text{ Se} \\ 10 \text{ V} \\ P-Ch \\ 10 \text{ Se} \\ 10 \text{ V} \\ P-Ch \\ 10 \text{ Se} \\ 10 \text{ V} \\ P-Ch \\ 11 \text{ So} \\ 10 \text{ Se} \\ 10 \text{ V} \\ P-Ch \\ 12 \text{ Se} \\ 10 \text{ V} \\ P-Ch \\ 13 \text{ Se} \\ 10 \text{ Se} \\ 10 \text{ V} \\ P-Ch \\ 14 \text{ Se} \\ 10 \text{ V} \\ P-Ch \\ 15 \text{ Se} \\ 10 \text{ V} \\ P-Ch \\ 10 \text{ Se} \\ 10 \text{ V} \\$) .
Variable)
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	nA
$V_{DS} = 16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = 0 \ V, \ I_J = 85 \ C \\ V_{DS} = -16 \ V, V_{GS} = -4.5 \ V \\ V_{DS} = -1.5 \ V, \ I_D = 200 \ MA \\ V_{DS} = -150 \ MA \\ V_{DS} = -150 \ MA \\ V_{DS} = -150 \ MA \\ V_{DS} = -16 \ V, V_{DS} = -150 \ MA \\ V_{DS} = -16 \ V, V_{DS} = -160 \ MA \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ V, V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ V, V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ V, V_{DS} = -160 \ V, V_{DS} = -160 \ M, V_{DS} = 0 \ V \\ V_{DS} = -160 \ V, V_{DS} = -160 \ V, V_{DS} = -160 \ M, V_{DS} $) "
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	μΑ
On-State Drain Current ^a ID(on) V _{DS} = - 5 V, V _{GS} = - 4.5 V P-Ch - 200 Drain-Source On-State Resistance ^a Page 18 / P _{Ch}	μΑ
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	A
$P-Ch = \frac{12}{V_{GS} = -4.5 \text{ V, } I_D = -150 \text{ mA}} = \frac{12}{V_{GS} = 2.5 \text{ V, } I_D = 175 \text{ mA}} = \frac{12}{V_{GS} = 2.5 \text{ V, } I_D = 175 \text{ mA}} = \frac{12}{V_{GS} = 2.5 \text{ V, } I_D = 125 \text{ mA}} = \frac{12}{V_{GS} = 2.5 \text{ V, } I_D = 125 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 1.8 \text{ V, } I_D = 150 \text{ mA}} = \frac{12}{V_{GS} = 10 \text{ V, } I_D = 150 $	mA
$ P_{Drain-Source On-State} = P_{DS(on)} = $	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Ω
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$V_{DS} = -1.5 \text{ V, } I_{D} = -30 \text{ mA} \qquad P-Ch \qquad 200 \text{ mA} \qquad V_{DS} = 10 \text{ V, } I_{D} = 200 \text{ mA} \qquad N-Ch \qquad 0.5 \qquad 0.5 \qquad V_{DS} = -10 \text{ V, } I_{D} = -150 \text{ mA} \qquad P-Ch \qquad 0.4 \qquad 0.4 \qquad 0.4 \qquad 0.4 \qquad 0.4 \qquad 0.5 \qquad$	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
	S
Dynamic ^b Qg N-Channel N-Ch 750 P-Ch 1500 V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 150 mA N-Ch 75 N-Ch 75	. V
Total Gate Charge Q_g	
$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 150 \text{ mA}$	
Gate-Source Charge Q _{gs} P-Channel P-Ch 150	pC
Gate-Drain Charge Q_{qd} $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -150 \text{ mA}$ $\begin{array}{ c c c c c c c c c c c c c c c c c c c$	
P-Ch 450	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$I_D \cong 250 \text{ mA}, V_{GEN} = 4.5 \text{ V}, R_g = 10 \Omega$ P-Ch	ns
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	118
$I_D \cong$ - 150 mA, V_{GEN} = - 4.5 V, R_g = 10 Ω P-Ch	

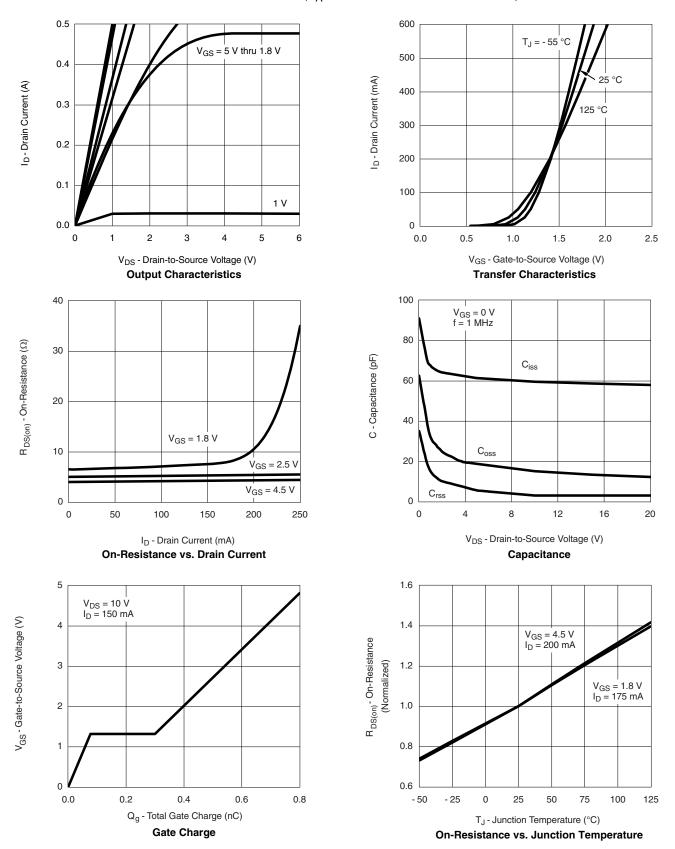
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



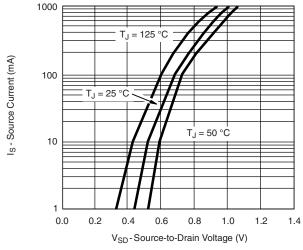
N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

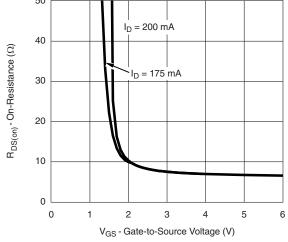


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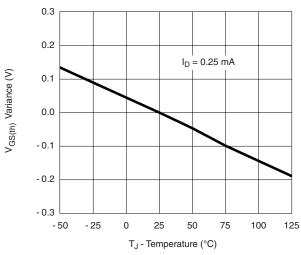
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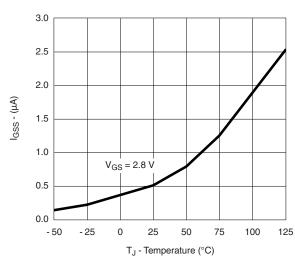




Source-Drain Diode Forward Voltage

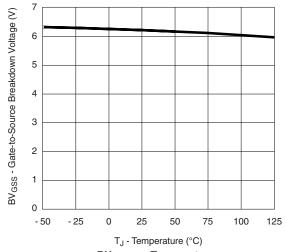
On-Resistance vs. Gate-to-Source Voltage





Threshold Voltage Variance vs. Temperature

I_{GSS} vs. Temperature

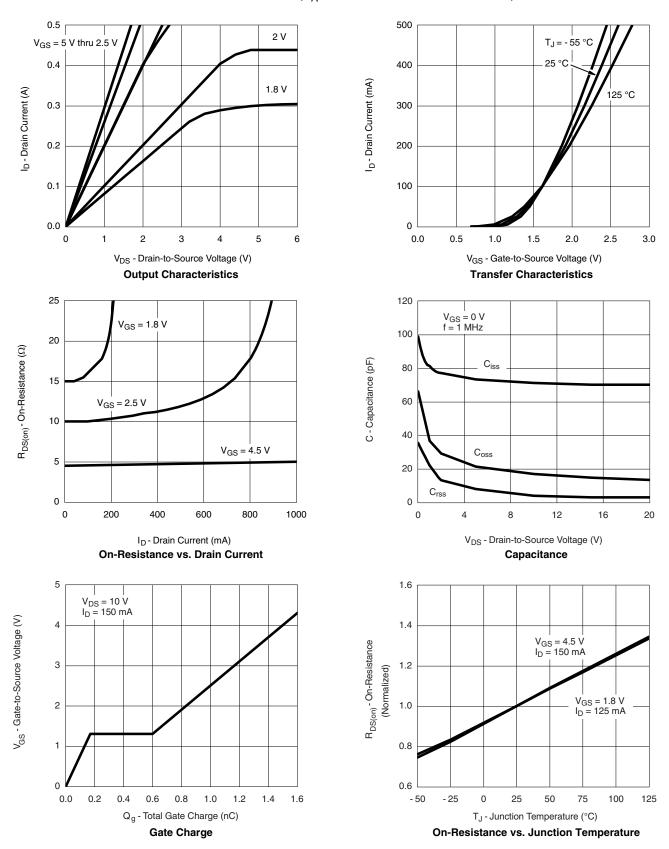


BV_{GSS} vs. Temperature





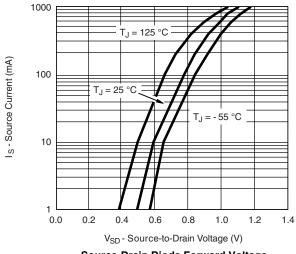
P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

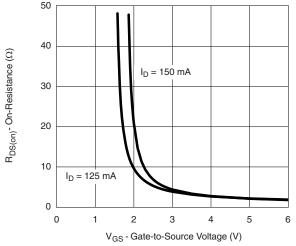


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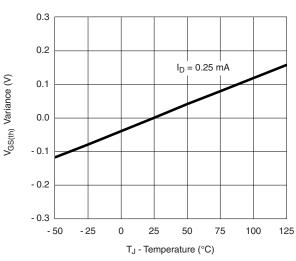
P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

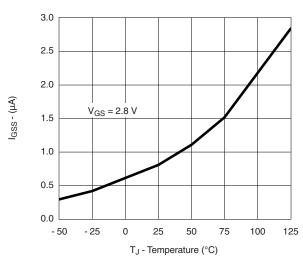




Source-Drain Diode Forward Voltage

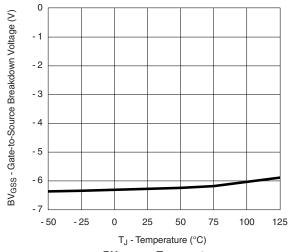
On-Resistance vs. Gate-to-Source Voltage



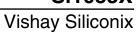


Threshold Voltage Variance vs. Temperature

I_{GSS} vs. Temperature

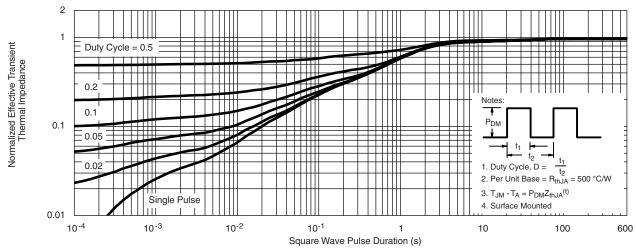


BV_{GSS} vs. Temperature





N- OR P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

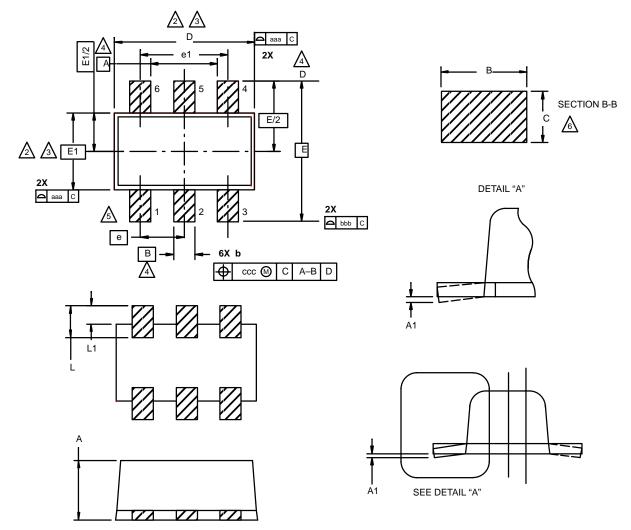


Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71426.



SC89: 6- LEADS (SOT-563F)



NOTES:

1. Dimensions in millimeters.



Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.



Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.



Datums A, B and D to be determined 0.10 mm from the lead tip.



Terminal numbers are shown for reference only.



These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

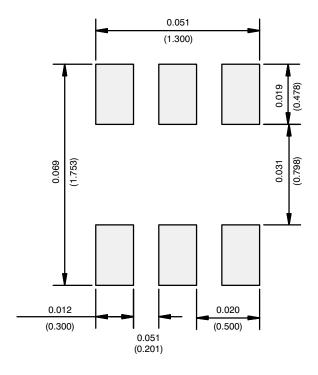
	MILLIMETERS				Tolerances
Dim	Min	Max	Note	Symbol	Of Form And Position
Α	0.56	0.60		aaa	0.10
A1	0.00	0.10		bbb	0.10
b	0.15	0.30		ccc	0.10
С	0.10	0.18			
D	1.50	1.70	2, 3		
E	1.55	1.70			
E1	1.20	BSC	2, 3		
е	0.50 BSC				
e1	1.00 BSC				
L	0.35 BSC				
L1	0.20 BSC				
ECN: E-00499—Rev. B, 02-Jul-01					

www.vishay.com

DWG: 5880



RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



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Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.